

HSTD12 - Development and Application of Semiconductor Tracking Detectors

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TOPICS:
Simulations
Technologies
Pixel and Strip Sensors
Radiation Tolerant Materials
ASICs
Large Scale Applications
Applications in Biology, Astrophysics, Medicine, ...
New Ideas and Future Applications

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Editorial

The 12th International “Hiroshima” Symposium on the Development and Application of Semiconductor Tracking Detectors (HSTD12) was held on December 15 - 18, 2017, at the International Conference Center Hiroshima, Hiroshima, Japan. The primary goal of the symposium is to bring together experts in the design, processing and applications for discussions of experiences, lessons learned and new ideas which are still in the early stage of development. The series of “Hiroshima” symposia has been held traditionally in the Pacific Rim region since the first symposium at Hiroshima in 1993. The proceedings of the symposia have been published in Nuclear Instruments and Methods [1, 2, 4, 5, 6, 7, 8, 9, 10, 11].

To the 12th symposium, a total number of 163 participants were registered with 143 contributions, among which 55 were assigned to oral presentations and 88 to posters. The topics of the contributions covered the field of semiconductor detectors and related areas, from technologies and simulations (10 and 2 contributions, respectively), pixel sensors for tracking and imaging (24 and 14), strip sensors (10), radiation damage and radiation tolerant materials (20 total), ASICs (20), large scale application in particle physics experiments (14), applications in astrophysics, biology, medicine, etc. (12 total), and new ideas and future applications (14 total). Following the tradition, the oral sessions were held as plenaries only, while posters sessions were scheduled throughout the entire symposium for presentation and discussion, with coffee, tea, and cookies, during the coffee/tea/lunch breaks.

In past symposia, we were witnessing the development of silicon-based tracking devices, shown in Fig. 1. The first generation of this evolution were strip sensors, followed by pixel sensors as the second generation. In this symposium, we have seen the birth of silicon-based fast timing detectors in large-scale applications, for the ATLAS and CMS experiments, that will be operational in the mid-2020’s.

The symposium was entertained with a welcome reception in the Conference Center in the evening of 14th, Saturday, and with a half-day break, in the afternoon of 16th, Monday, used for an excursion to Miyajima island where the world-heritage Itsukushima shrine and the sacred mountain “Misen” are, and with the symposium dinner, in the evening of 17th at Hiroshima-city Bunka Koryu Kaikan. The dinner was entertained with the “Kagura” (dance in dedication to the gods) performance by the dancing team “Saniwa Kagura-Dan”, provided by the Hiroshima Convention & Visitors Bureau. The group performed “Yamata no Orochi” - the story of a god who saved the life of an old couple’s daughter to be sacrificed to a big, eight-headed snake (embodied by three snakes in the dance), who the god charmed to sleep with “sake” and then defeated.

The symposium was supported by the Hiroshima Convention & Visitors Bureau, through Ms. A. Sawada of the MICE promotion department, which partially covered the fee for the Conference Center, organized a welcome message from the mayor of Hiroshima City, and the entertainment at the symposium dinner. The symposium was made possible by the excellent contributions of the local organizers, Profs. H. Takahashi and T. Mizuno of Hiroshima University, who not only managed and executed the symposium but also complemented a guest editor, Y. Fukazawa.

Among the 143 contributions, 109 papers were included for publication in these proceedings. Like previous issues, the papers were peer-reviewed with the help of many anonymous reviewers in the field, as well as a special guest editor, D. Bortoletto, in case of a conflict of interest of the managing guest editor, to whom the organizers wish to extend their appreciation. We also appreciate the support of the publisher’s editorial team: V. Letizia, L. Li, S. Vikram, and others.

The next Symposium will be held in Vancouver, Canada, in 2022¹.

Guest Editors

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¹Due to the pandemic of the new corona virus COVID-19, the 13th symposium is postponed by one year, from 2021 to 2022.

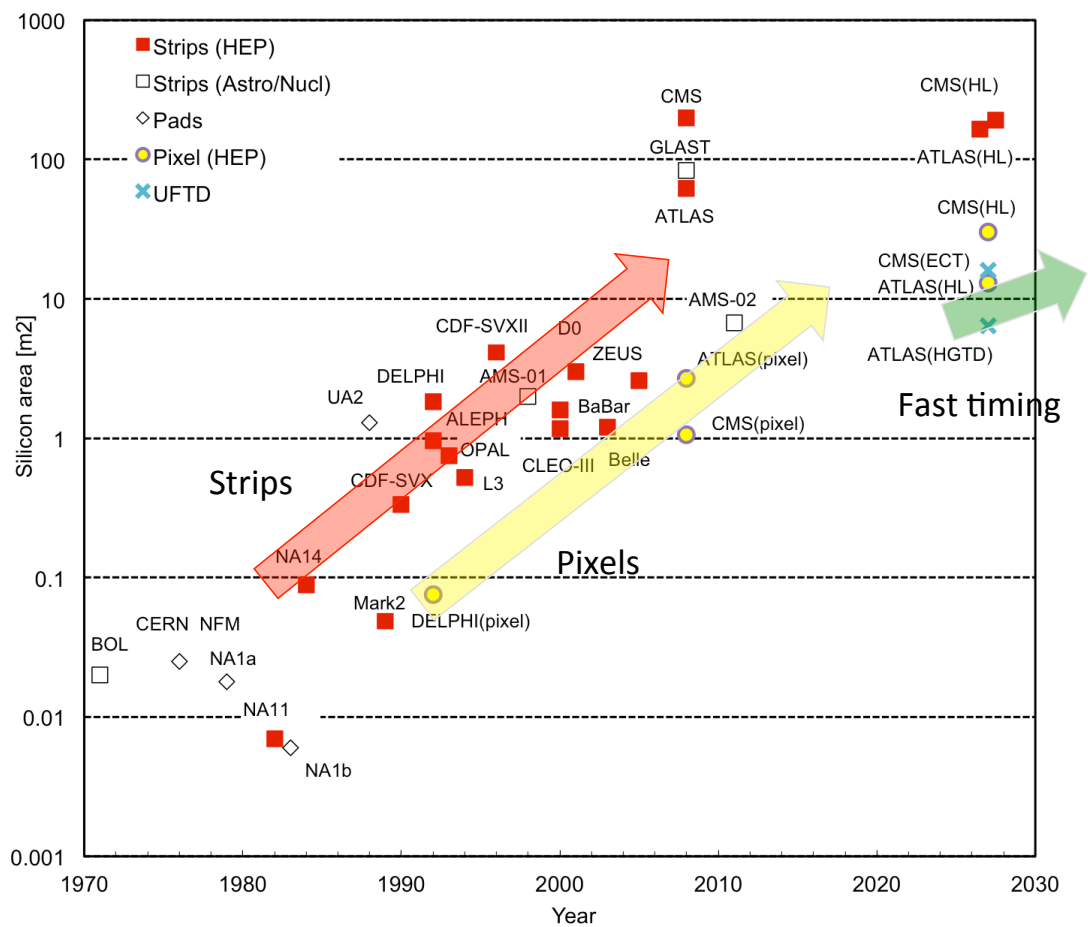


Fig. 1: Evolution of the area of silicon-based detectors. The first wave were strip sensors, followed by a second wave of pixel sensors. A new generation of fast timing detectors with large-scale applications is being developed.

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Symposium Photos



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on the steps of “the Conference Center relief”

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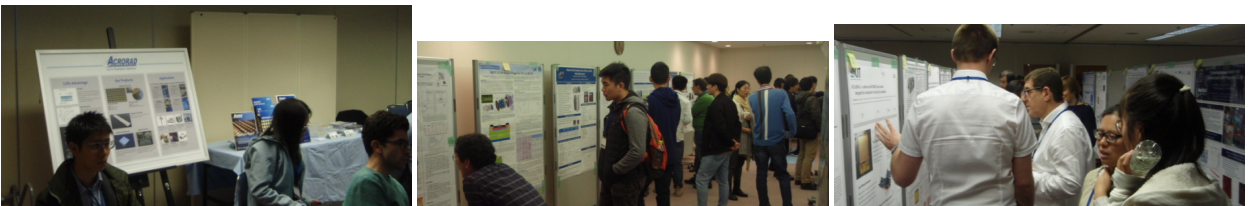
121



122

plenary session

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125

poster sessions throughout the symposium, with coffee/tea/cookies



131 poster sessions throughout the symposium, with coffee/tea/cookies



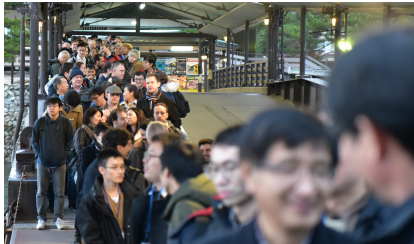
133 Peace Memorial Park at sunrise, Conference Center on the left



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Welcome Reception the night before the Symposium



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Excursion to Miyajima Island: ferry, shrine, and town



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at the vista point of "Lion's nose" of mount "Misen", with the scenery of Hiroshima city in the background



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Symposium dinner at Hiroshima City Bunka Kouryu Kaikan

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happy faces

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the entertainment: "Kagura" (dance in dedication to the gods), "Yamata-no-Orochi", and aftermath



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Symposium dinner opening and closing by the founders of the symposium